

致尊敬的顾客

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## 关于产品目录等资料中的旧公司名称

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瑞萨电子公司网址：<http://www.renesas.com>

2010年4月1日  
瑞萨电子公司

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## 单逻辑 IC

### 单逻辑 IC 的型号

#### 1. 单逻辑 IC 的型号

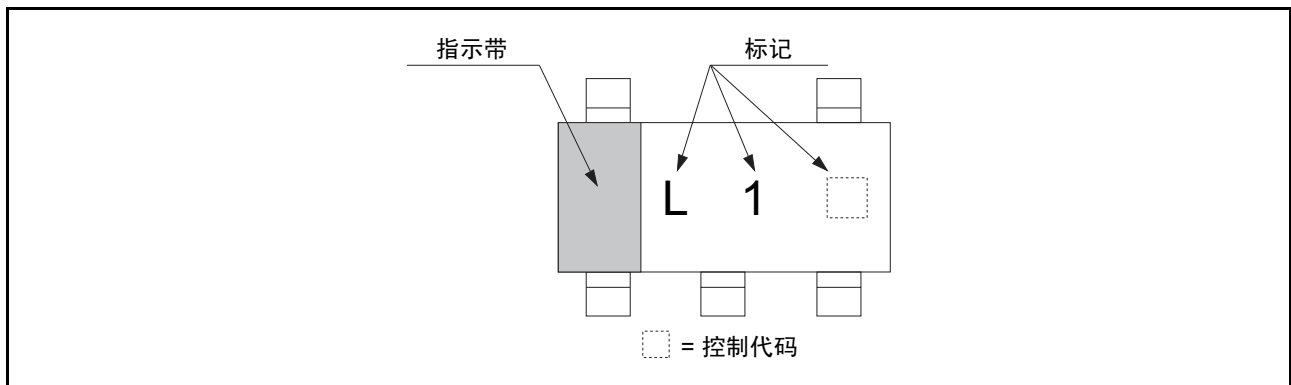
HD74UH	<input type="text"/>		EL	带包装代码 包装单位: 3,000个/卷
HD74HC1G/HCT1G/LV1G/LV1GT	<input type="text"/>	CM	E	
HD74LV1G/LV1GT/ALVC1G	<input type="text"/>	VS	E	
HD74LV2G/LV2GT/ALVC2G	<input type="text"/>	US	E	
HD74LVC1G/LVC2G/LVC3G	<input type="text"/>	CP	E	
HD74LVC1G/LVC2G/LVC3G	<input type="text"/>	CL	E	

各产品的品种代码

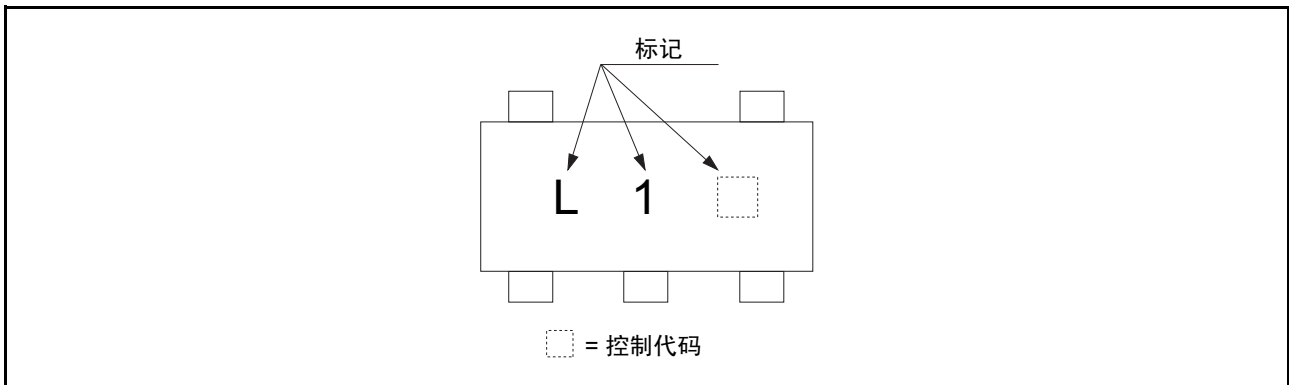
封装代码  
 无: MPAK-5 (MPAK-5)  
 CM: CMPAK-5 (CMPAK-5)  
 VS: VSON-5 (TNP-5D)  
 US: SSOP-8 (TTP-8DB)  
 CP: NanoFree (TBS-5V/TBS-6V/TBS-8V)  
 CL: NanoFree / Large Ball品 (开发中)

#### 2. 封装上的标记

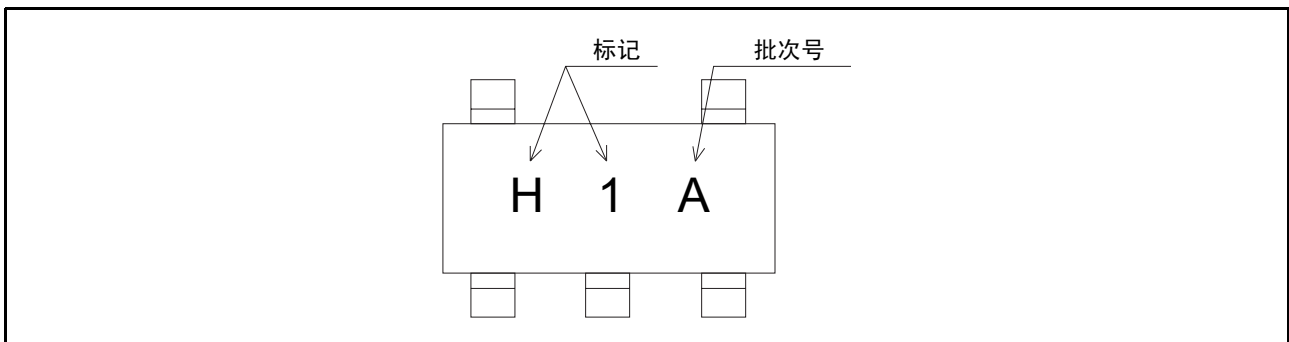
(1) CMPAK 封装 5 个引脚



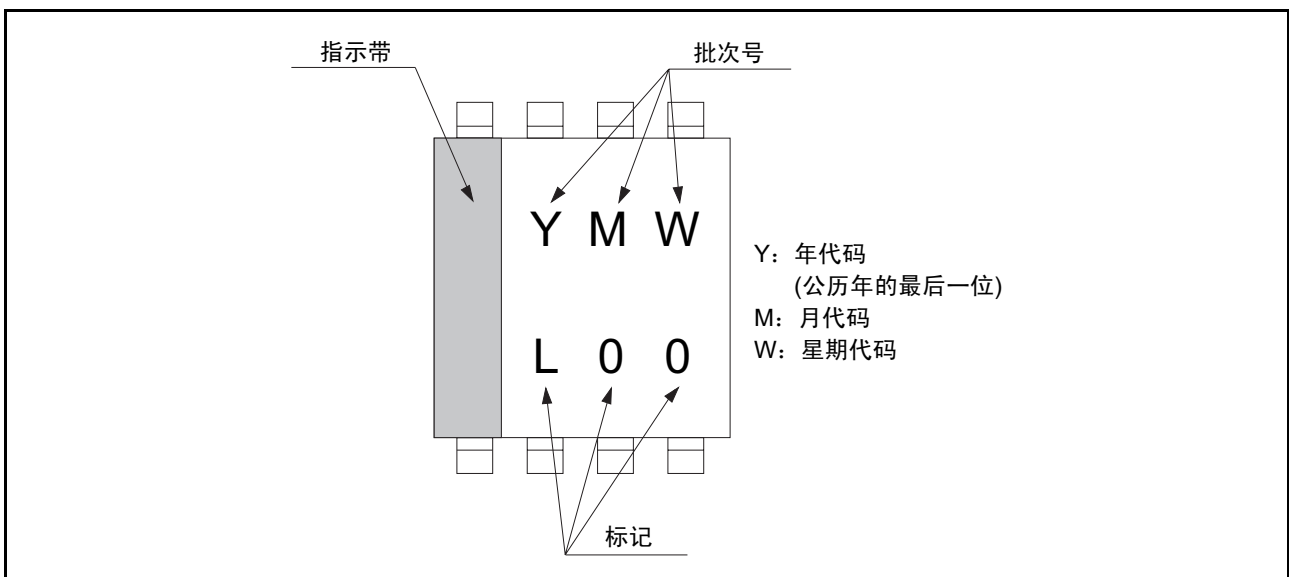
(2) VSON封装 5个引脚



(3) MPAK-5封装 5个引脚



(4) SSOP封装 8个引脚



## 3. 产品名标记对应表

品名	系列名												
	UH	HC1G	HCT 1G	LV1G-A	LV1G T-A	LV1G W-A	LV2G A	LV2G T-A	LVC 1G	LVC 2G	LVC 3G	ALVC 1G	ALVC 2G
00	H1	H1	F1	L1	T1	—	L00	T00	E1	E00	—	A1	A00
02	H3	H3	F3	L3	T3	—	L02	T02	E3	E02	—	A3	A02
04	H5	H5	F5	L5	T5	W5	L04	T04	E5	K5	E04	A5	A04
U04	—	H6	—	L6	—	W6	LU4	—	E6	K6	EU4	—	—
06	—	—	—	—	—	WD	—	—	ED	KD	E06	AD	A06
07	—	—	—	—	—	WE	—	—	EE	KE	E07	AE	A07
08	H2	H2	F2	L2	T2	—	L08	T08	E2	E08	—	A2	A08
14	—	HA	FA	LA	TA	WA	L14	T14	EA	KA	E14	AA	A14
16	—	—	—	—	—	WJ	—	—	—	—	—	—	—
17	—	—	—	—	—	WK	—	—	EK	KK	E17	—	—
18	—	—	—	—	—	—	—	—	KL	—	—	—	—
32	H4	H4	F4	L4	T4	—	L32	T32	E4	E32	—	A4	A32
34	—	—	—	—	—	—	L34	T34	—	KJ	E34	—	A34
53	—	—	—	—	—	WP	L53	T53	KP	E53	—	—	A53
57	—	—	—	—	—	WR	—	—	KR	—	—	—	—
58	—	—	—	—	—	WT	—	—	KT	—	—	—	—
66	H9	H9	F9	L9	T9	—	L66	T66	E9	E66	—	A9	A66
74	—	—	—	—	—	—	L74	T74	—	E74	—	—	A74
79	—	—	—	—	—	—	—	—	EF	—	—	AF	—
80	—	—	—	—	—	—	—	—	EG	—	—	AG	—
86	—	H8	F8	L8	T8	—	—	T86	E8	E86	—	A8	A86
97	—	—	—	—	—	W2	—	—	K2	—	—	—	—
98	—	—	—	—	—	W1	—	—	K1	—	—	—	—
123	—	—	—	—	—	—	L23	T23	—	—	—	—	—
125	—	—	—	LB	TB	—	L25	T25	EB	E25	—	AB	A25
126	—	—	—	LC	TC	—	L26	T26	EC	E26	—	AC	A26
157	—	—	—	—	—	—	L57	T57	—	E57	—	—	A57
240	—	—	—	—	—	—	L40	T40	EH	E40	—	AH	A40
241	—	—	—	—	—	—	L41	T41	—	E41	—	—	A41
245	—	—	—	—	—	—	L45	T45	—	—	—	—	A45

修订记录

Rev.	发行日	修订内容	
		页	修订处
1.00	2008.03.25	一	初版发行

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